

To our customers,

Old Company Name in Catalogs and Other Documents

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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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MOS FIELD EFFECT TRANSISTOR

μ PA2716AGR

SWITCHING

P-CHANNEL POWER MOS FET

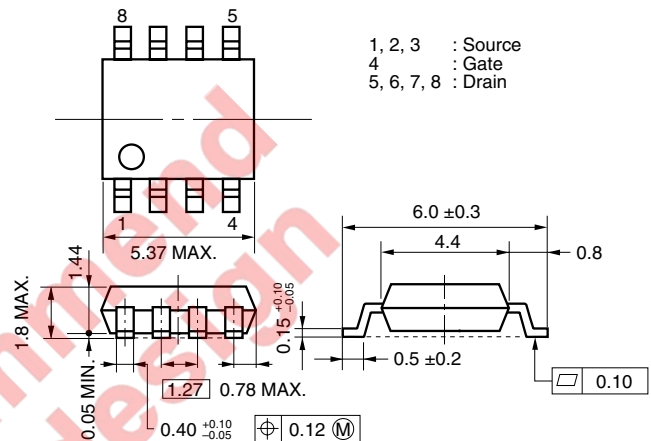
DESCRIPTION

The μ PA2716AGR is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Lithium-Ion battery protection circuit.

FEATURES

- Low on-state resistance
 $R_{DS(on)1} = 7.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = -10 \text{ V, } I_D = -7.0 \text{ A)}$
 $R_{DS(on)2} = 11.3 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -7.0 \text{ A)}$
- Low input capacitance
 $C_{iss} = 3000 \text{ pF TYP.}$
- Built-in gate protection diode
- Small and surface mount package (Power SOP8)

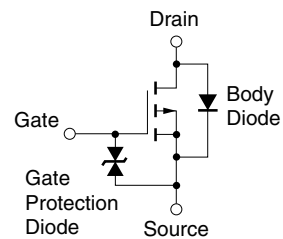
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	-30	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC)	I _{D(DC)}	±14	A
Drain Current (pulse) ^{Note1}	I _{D(pulse)}	±140	A
Total Power Dissipation ^{Note2}	P _{T1}	2	W
Total Power Dissipation ^{Note3}	P _{T2}	2	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C
Single Avalanche Current ^{Note4}	I _{AS}	-14	A
Single Avalanche Energy ^{Note4}	E _{AS}	19.6	mJ

EQUIVALENT CIRCUIT



Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Mounted on ceramic substrate of 1200 mm² x 2.2 mm
3. Mounted on glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mm, PW = 10 sec
4. Starting T_{ch} = 25°C, V_{DD} = -15 V, R_G = 25 Ω, L = 100 μH, V_{GS} = -20 → 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

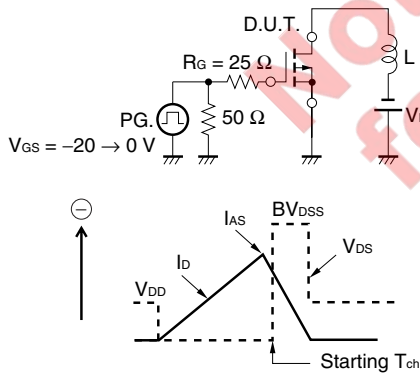
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ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

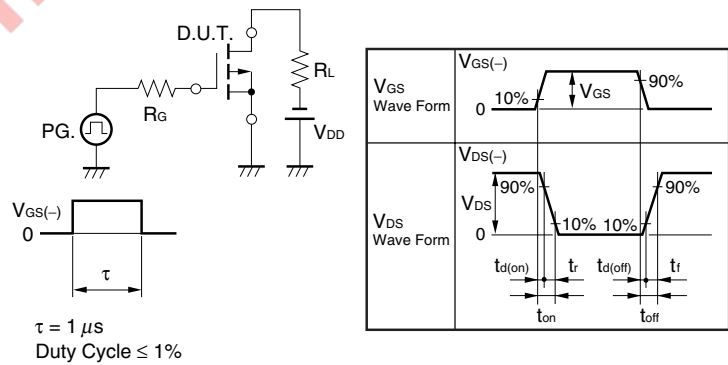
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$			-1	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$			±10	μA
Gate to Source Cut-off Voltage	$V_{GS(off)}$	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$	-1.0		-2.5	V
Forward Transfer Admittance ^{Note}	$ y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -7.0\text{ A}$	10			S
Drain to Source On-state Resistance ^{Note}	$R_{DS(on)1}$	$V_{GS} = -10\text{ V}, I_D = -7.0\text{ A}$		5.5	7.0	mΩ
	$R_{DS(on)2}$	$V_{GS} = -4.5\text{ V}, I_D = -7.0\text{ A}$		7.3	11.3	mΩ
	$R_{DS(on)3}$	$V_{GS} = -4.0\text{ V}, I_D = -7.0\text{ A}$		8.3	13.5	mΩ
Input Capacitance	C_{iss}	$V_{DS} = -10\text{ V}$		3000		pF
Output Capacitance	C_{oss}	$V_{GS} = 0\text{ V}$		960		pF
Reverse Transfer Capacitance	C_{rss}	$f = 1\text{ MHz}$		500		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -15\text{ V}, I_D = -7.0\text{ A}$		14		ns
Rise Time	t_r	$V_{GS} = -10\text{ V}$		19		ns
Turn-off Delay Time	$t_{d(off)}$	$R_G = 10\ \Omega$		680		ns
Fall Time	t_f			340		ns
Total Gate Charge	Q_G	$V_{DD} = -24\text{ V}$		95		nC
Gate to Source Charge	Q_{GS}	$V_{GS} = -10\text{ V}$		11		nC
Gate to Drain Charge	Q_{GD}	$I_D = -14\text{ A}$		25		nC
Body Diode Forward Voltage ^{Note}	$V_{F(S-D)}$	$I_F = 14\text{ A}, V_{GS} = 0\text{ V}$		0.83		V
Reverse Recovery Time	t_{rr}	$I_F = 14\text{ A}, V_{GS} = 0\text{ V}$		380		ns
Reverse Recovery Charge	Q_{rr}	$di/dt = 50\text{ A}/\mu\text{s}$		690		nC

Note Pulsed

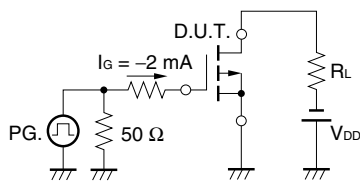
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

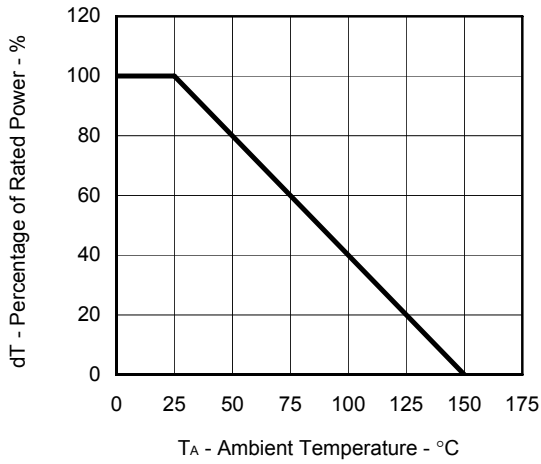


TEST CIRCUIT 3 GATE CHARGE

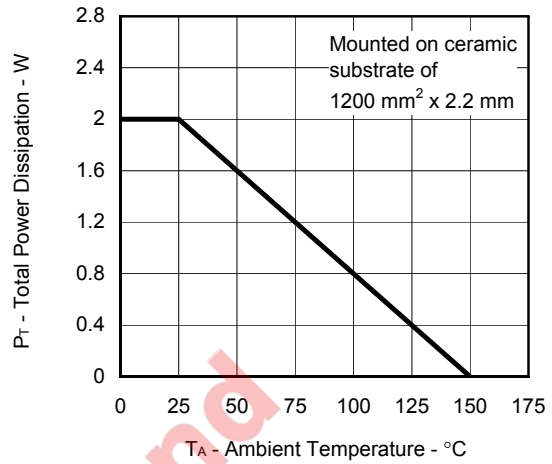


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

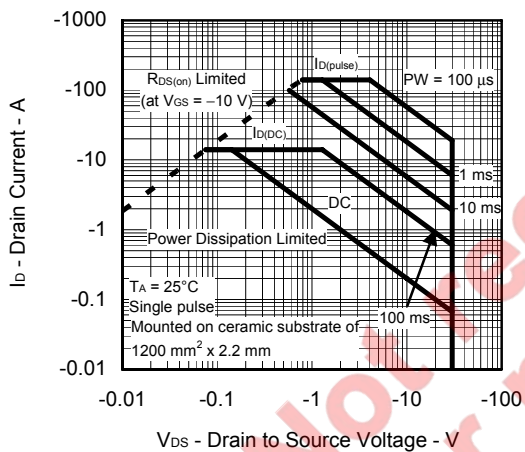
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



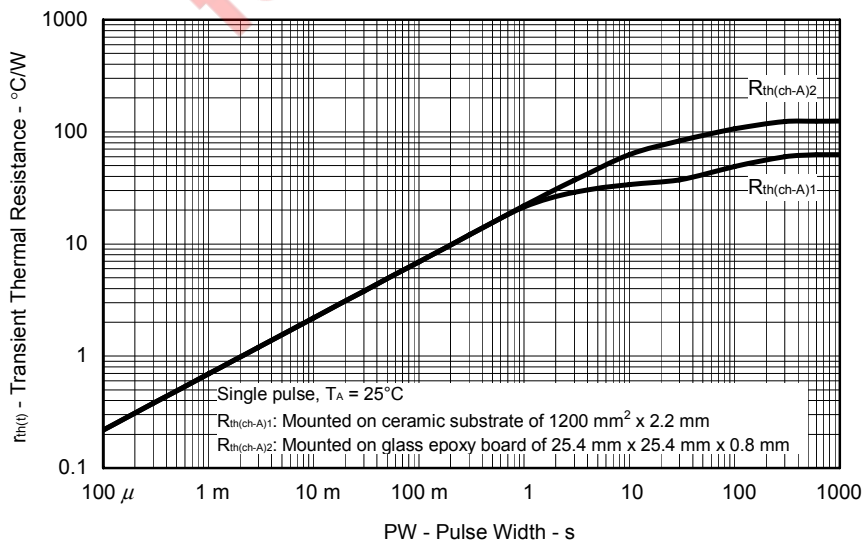
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



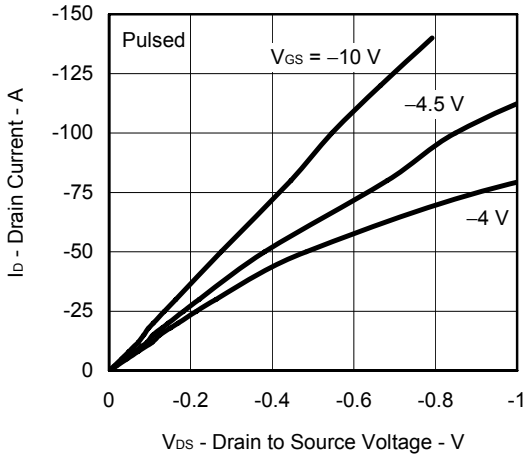
FORWARD BIAS SAFE OPERATING AREA



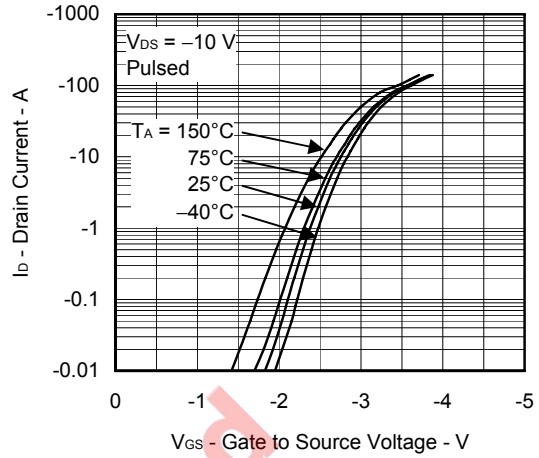
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



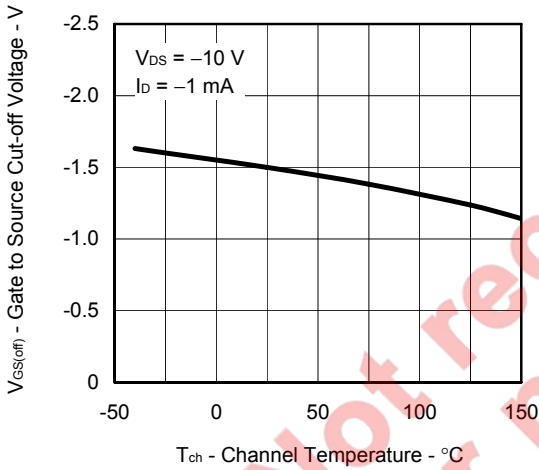
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



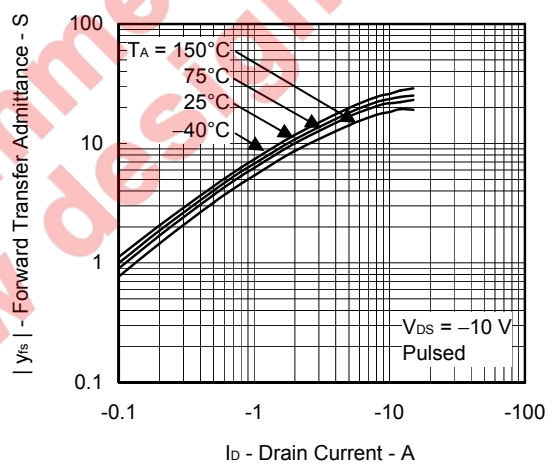
FORWARD TRANSFER CHARACTERISTICS



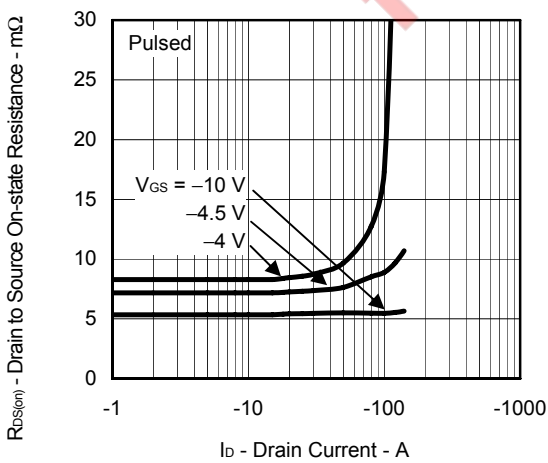
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



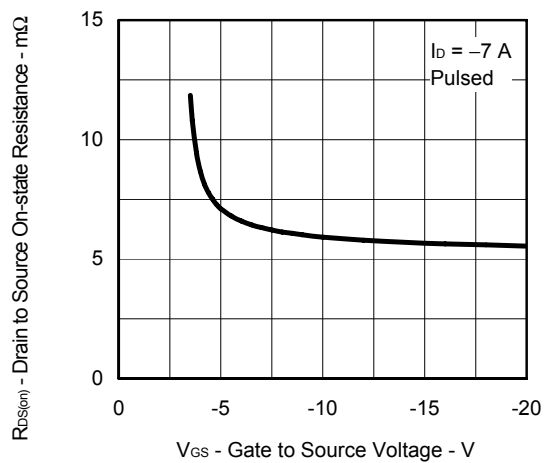
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



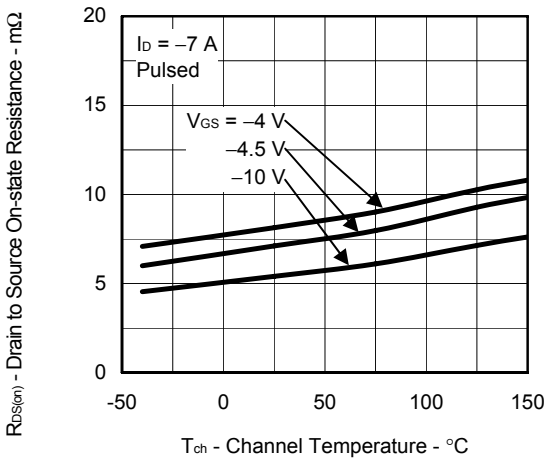
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



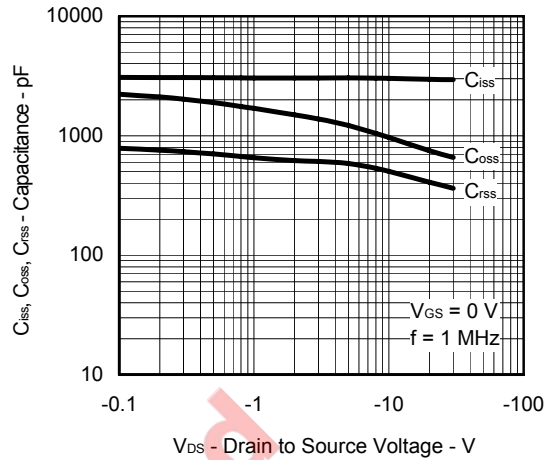
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



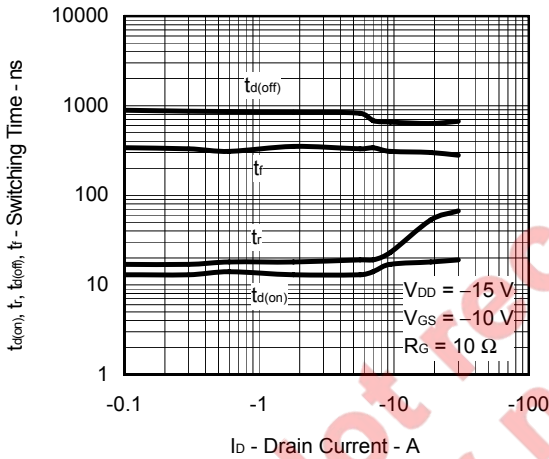
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



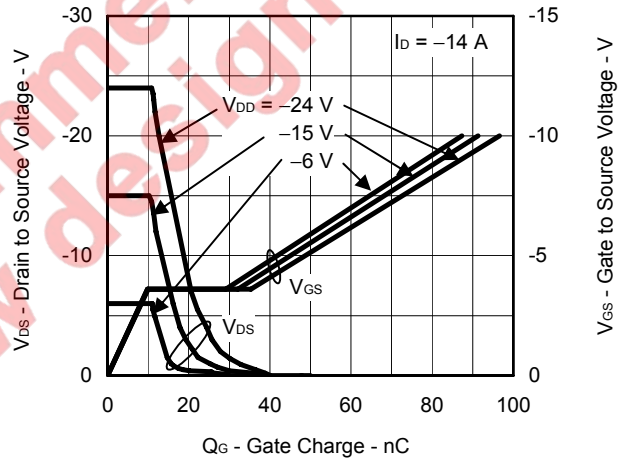
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



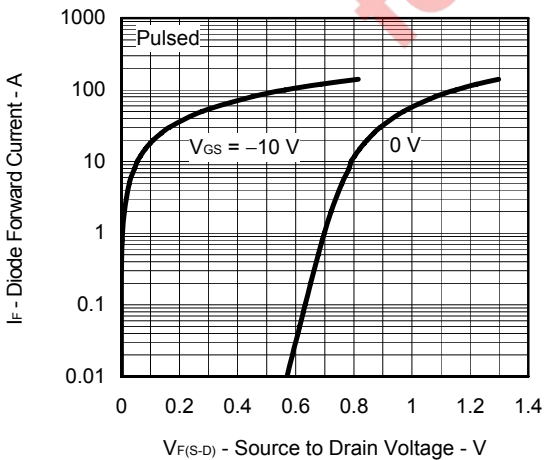
SWITCHING CHARACTERISTICS



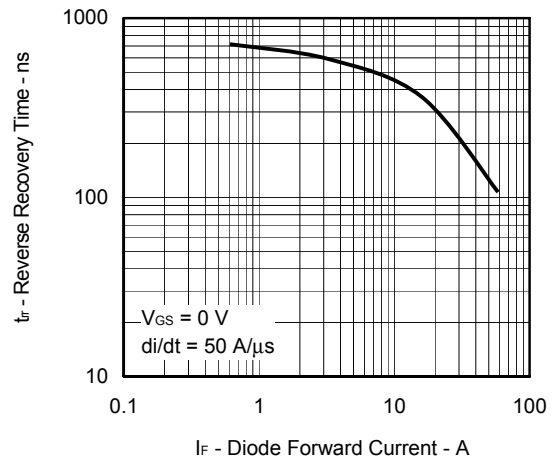
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



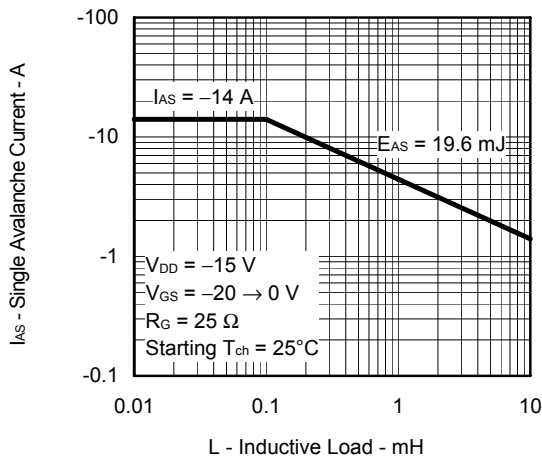
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



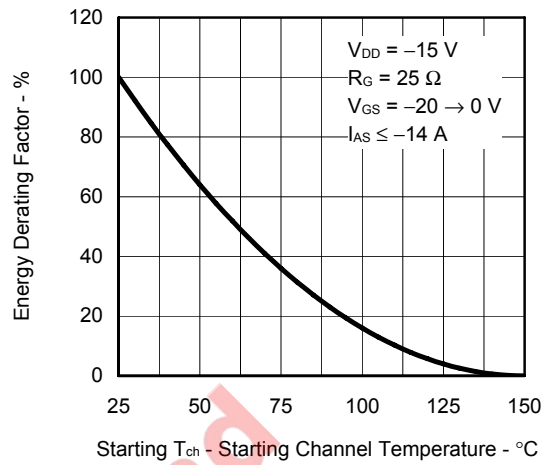
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
μ PA2716AGR-E1-AT ^{Note}	Pure Sn (Tin)	Tape 2500 p/reel	Power SOP8
μ PA2716AGR-E2-AT ^{Note}			0.08 g TYP.

Note Pb-free (This product does not contain Pb in external electrode and other parts.)

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